

Electronic Acknowledgement Receipt

EFS ID:	2936321
Application Number:	10823970
International Application Number:	
Confirmation Number:	5318
Title of Invention:	Semiconductor device having a pad metal layer and a lower metal layer that are electrically coupled, whereas apertures are formed in the lower metal layer below a center area of the pad metal layer
First Named Inventor/Applicant Name:	Hiroyuki Ogawa
Customer Number:	71326
Filer:	Reginald A. Ratliff/Christina Holland
Filer Authorized By:	Reginald A. Ratliff
Attorney Docket Number:	AMD-AFO1215
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Application Type:	Utility under 35 USC 111(a)

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Submitted with Payment	yes
Payment Type	Electronic Funds Transfer
Payment was successfully received in RAM	\$810
RAM confirmation Number	3703
Deposit Account	
Authorized User	

File Listing:

Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
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1		SPSN-AF01215.pdf	82587 <small>3ced1128bd8a6e6a35143ef7c17b5ee73b07068</small>	yes	10
Multipart Description/PDF files in .zip description					
Document Description		Start	End		
Amendment Submitted/Entered with Filing of CPA/RCE		1	1		
Claims		2	4		
Applicant Arguments/Remarks Made in an Amendment		5	10		
Warnings:					
Information:					
2	Fee Worksheet (PTO-06)	fee-info.pdf	8276 <small>145040302648514fc362b23c00a5e1fb9c2392f</small>	no	2
Warnings:					
Information:					
Total Files Size (in bytes):			90863		
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